

RJK5018DPK

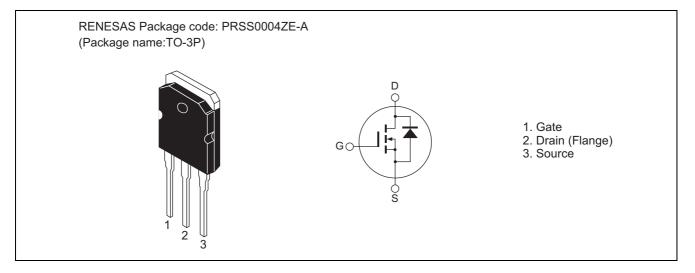
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1457-0100 Rev.1.00 May 11, 2006

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



Absolute Maximum Ratings

		$(Ta = 25^{\circ}C)$
Symbol	Ratings	Unit
V _{DSS}	500	V
V _{GSS}	±30	V
Ι _D	35	А
Note1 I _{D (pulse)}	105	А
I _{DR}	35	А
Note1 I _{DR (pulse)}	105	А
I _{AP} ^{Note3}	9	А
E _{AR} ^{Note3}	4.5	mJ
Pch Note2	200	W
θch-c	0.625	°C/W
Tch	150	٥°
Tstg	-55 to +150	٥°
	VDSS VGSS ID ID (pulse) Note1 IDR (pulse) IAP Note3 EAR Pch Note2 0ch-c Tch	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25° C

3. STch = 25° C, Tch $\leq 150^{\circ}$ C



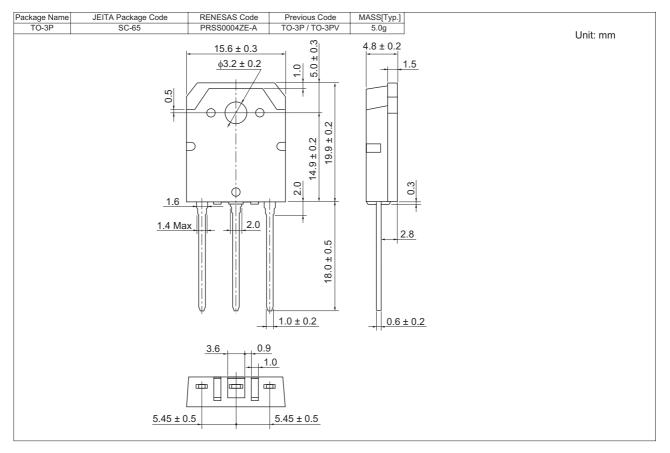
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	500	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	1	μΑ	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS(on)}	_	0.130	0.155	Ω	$I_D = 17.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	4100		pF	V _{DS} = 25 V
Output capacitance	Coss	_	420		pF	V _{GS} = 0 f = 1 MHz
Reverse transfer capacitance	Crss	_	50		pF	
Turn-on delay time	t _{d(on)}	_	50		ns	I _D = 17.5 A
Rise time	tr	_	99		ns	$V_{GS} = 10 V$ $R_L = 14.3 \Omega$ $Rg = 10 \Omega$
Turn-off delay time	t _{d(off)}	_	144		ns	
Fall time	t _f	_	93		ns	
Total gate charge	Qg	_	104		nC	V _{DD} = 400 V
Gate to source charge	Qgs	_	21		nC	V _{GS} = 10 V I _D = 35 A
Gate to drain charge	Qgd	_	46		nC	
Body-drain diode forward voltage	V _{DF}	_	0.92	1.55	V	$I_F = 35 \text{ A}, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery time	t _{rr}		430	—	ns	$I_F = 35 \text{ A}, V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu \text{s}$

Notes: 4. Pulse test



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
RJK5018DPK-00	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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